

Global Chip Level Underfill Adhesives Market 2025 by Manufacturers, Regions, Type and Application, Forecast to 2031

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Abstracts

According to our (Global Info Research) latest study, the global Chip Level Underfill Adhesives market size was valued at US\$ million in 2024 and is forecast to a readjusted size of USD million by 2031 with a CAGR of %during review period.

The global market for semiconductor was estimated at US\$ 579 billion in the year 2022, is projected to US\$ 790 billion by 2029, growing at a CAGR of 6% during the forecast period. Although some major categories are still double-digit year-over-year growth in 2022, led by Analog with 20.76%, Sensor with 16.31%, and Logic with 14.46% growth, Memory declined with 12.64% year over year. The microprocessor (MPU) and microcontroller (MCU) segments will experience stagnant growth due to weak shipments and investment in notebooks, computers, and standard desktops. In the current market scenario, the growing popularity of IoT-based electronics is stimulating the need for powerful processors and controllers. Hybrid MPUs and MCUs provide real-time embedded processing and control for the topmost IoT-based applications, resulting in significant market growth. The Analog IC segment is expected to grow gradually, while demand from the networking and communications industries is limited. Few of the emerging trends in the growing demand for Analog integrated circuits include signal conversion, automotive-specific Analog applications, and power management. They drive the growing demand for discrete power devices.

This report is a detailed and comprehensive analysis for global Chip Level Underfill Adhesives market. Both quantitative and qualitative analyses are presented by manufacturers, by region & country, by Type and by Application. As the market is constantly changing, this report explores the competition, supply and demand trends, as well as key factors that contribute to its changing demands across many markets.

Company profiles and product examples of selected competitors, along with market share estimates of some of the selected leaders for the year 2025, are provided.

Key Features:

Global Chip Level Underfill Adhesives market size and forecasts, in consumption value (\$ Million), sales quantity (Tons), and average selling prices (US\$/Kg), 2020-2031

Global Chip Level Underfill Adhesives market size and forecasts by region and country, in consumption value (\$ Million), sales quantity (Tons), and average selling prices (US\$/Kg), 2020-2031

Global Chip Level Underfill Adhesives market size and forecasts, by Type and by Application, in consumption value (\$ Million), sales quantity (Tons), and average selling prices (US\$/Kg), 2020-2031

Global Chip Level Underfill Adhesives market shares of main players, shipments in revenue (\$ Million), sales quantity (Tons), and ASP (US\$/Kg), 2020-2025

The Primary Objectives in This Report Are:

- To determine the size of the total market opportunity of global and key countries
- To assess the growth potential for Chip Level Underfill Adhesives
- To forecast future growth in each product and end-use market
- To forecast future factors affecting the marketplace

This report profiles key players in the global Chip Level Underfill Adhesives market based on the following parameters - company overview, sales quantity, revenue, price, gross margin, product portfolio, geographical presence, and key developments. Key companies covered as a part of this study include Henkel, Won Chemical, NAMICS, Showa Denko, Panasonic, MacDermid (Alpha Advanced Materials), Shin-Etsu, Sunstar, Fuji Chemical, Zymet, etc.

This report also provides key insights about market drivers, restraints, opportunities, new product launches or approvals.

Market Segmentation

Chip Level Underfill Adhesives market is split by Type and by Application. For the

period 2020-2031, the growth among segments provides accurate calculations and forecasts for consumption value by Type, and by Application in terms of volume and value. This analysis can help you expand your business by targeting qualified niche markets.

Market segment by Type

Chip-on-film Underfills

Flip Chip Underfills

CSP/BGA Board Level Underfills

Market segment by Application

Industrial Electronics

Defense & Aerospace Electronics

Consumer Electronics

Automotive Electronics

Medical Electronics

Others

Major players covered

Henkel

Won Chemical

NAMICS

Showa Denko

Panasonic

MacDermid (Alpha Advanced Materials)

Shin-Etsu

Sunstar

Fuji Chemical

Zymet

Shenzhen Dover

Threebond

AIM Solder

Darbond Technology

Master Bond

Hanstars

Nagase ChemteX

LORD Corporation

Asec Co., Ltd.

Everwide Chemical

Bondline

Panacol-Elosol

United Adhesives

U-Bond

Shenzhen Cooteck Electronic Material Technology

Market segment by region, regional analysis covers

North America (United States, Canada, and Mexico)

Europe (Germany, France, United Kingdom, Russia, Italy, and Rest of Europe)

Asia-Pacific (China, Japan, Korea, India, Southeast Asia, and Australia)

South America (Brazil, Argentina, Colombia, and Rest of South America)

Middle East & Africa (Saudi Arabia, UAE, Egypt, South Africa, and Rest of Middle East & Africa)

The content of the study subjects, includes a total of 15 chapters:

Chapter 1, to describe Chip Level Underfill Adhesives product scope, market overview, market estimation caveats and base year.

Chapter 2, to profile the top manufacturers of Chip Level Underfill Adhesives, with price, sales quantity, revenue, and global market share of Chip Level Underfill Adhesives from 2020 to 2025.

Chapter 3, the Chip Level Underfill Adhesives competitive situation, sales quantity, revenue, and global market share of top manufacturers are analyzed emphatically by landscape contrast.

Chapter 4, the Chip Level Underfill Adhesives breakdown data are shown at the regional level, to show the sales quantity, consumption value, and growth by regions, from 2020 to 2031.

Chapter 5 and 6, to segment the sales by Type and by Application, with sales market share and growth rate by Type, by Application, from 2020 to 2031.

Chapter 7, 8, 9, 10 and 11, to break the sales data at the country level, with sales quantity, consumption value, and market share for key countries in the world, from 2020 to 2025. and Chip Level Underfill Adhesives market forecast, by regions, by Type, and by Application, with sales and revenue, from 2026 to 2031.

Chapter 12, market dynamics, drivers, restraints, trends, and Porters Five Forces analysis.

Chapter 13, the key raw materials and key suppliers, and industry chain of Chip Level Underfill Adhesives.

Chapter 14 and 15, to describe Chip Level Underfill Adhesives sales channel, distributors, customers, research findings and conclusion.

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